## **ASSP**

# Piezoelectric VCO (6 to 30 MHz)

# M2 Series (F150)

#### **■ DESCRIPTION**

The M2 series (F150) of VCO (Voltage Controlled Oscillator) apply to the frequency range 6 to 30 MHz. These VCOs have a high stability and wide controllable frequency ranges using a LiTaO<sub>3</sub> piezoelectric single crystal with high electromechanical coupling coefficient. Output level applies to CMOS type for digital interface.

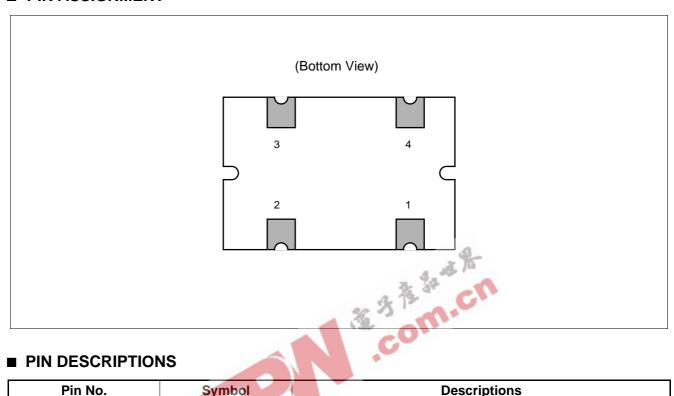
#### **■ FEATURES**

- Wide frequency controllable range (Over than ±2000 ppm)
- · High carrier noise ratio
- Excellent temperature stability
- CMOS output level
- Compact package (8 × 11 × 2.6 mm)
- Surface mountable package (SMD)

#### ■ PACKAGE



#### **■ PIN ASSIGNMENT**



## **■ PIN DESCRIPTIONS**

Pin No.	Symbol	Descriptions
1	Vin	INPUT (Control voltage)
2	GND	GROUND
3	Vcc	Vcc (Supply voltage)
4	Vouт	OUTPUT

#### ■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rat	Unit		
Farameter	Symbol	Min.	Max.	Oille	
Supply voltage	Vcc	-0.5	+7.0	V	
Control voltage	Vin	-0.5	+7.0	V	
Output voltage	Vouт	-0.5	Vcc +0.5	V	
Output current	Іоит	-25	+25	mA	
Operating temperature	Ta	-10	+70	°C	
Storage temperature	T <sub>stg</sub>	-40	+100	°C	

WARNING: Piezoelectric devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

#### **■ RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Value		Unit
Farameter	Symbol	Min.	Max.	Offic
Supply voltage	Vcc	+4.75	+5.25	V
Control voltage	Vin	0	+5.0	V
Operating temperature	Та	-10	+70	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the piezoelectric device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

#### **■ STANDARD FREQUENCIES**

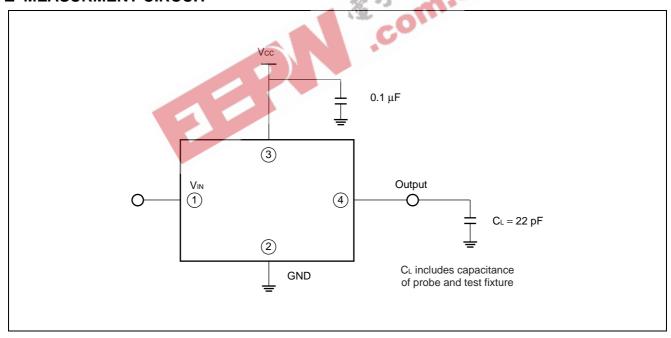
Nominal frequency	Part number	Application		
14.318 MHz	FAR-M2CC-14M318-F150	Video		
16.934 MHz	FAR-M2CC-16M934-F150	Audio		
18.432 MHz	FAR-M2CC-18M432-F150	Video		
24.576 MHz	FAR-M2CC-24M576-F150	Audio		
25.175 MHz	FAR-M2CC-25M175-F150	Display		

#### **■ ELECTRICAL CHARACTERISTICS**

Parameter		Symbol	Condition	Value			Unit	Remarks
				Min.	Тур.	Max.	Ullit	Remarks
Current consumption		Icc	Without load	_	5.0	10	mA	
Output voltage	"H"	Vон	V <sub>IN</sub> = 2.5 V	Vcc - 0.5	5.0	_	V	
	"L"	Vol		_	0	+0.5	V	
Oscillation frequency		fн	VIN = 5.0 V	+2000	_	_	ppm	Nominal
		f∟	VIN = 0.0 V	_	_	-2000	ppm	frequency reference
Frequency stability		Δf(Vcc)	Vcc = 4.75 V to 5.25 V V <sub>IN</sub> = 2.5 V	-150	_	+150	ppm	Vcc = 5.0 V reference
Frequency stability with temperature		∆f(Ta)	V <sub>IN</sub> = 2.5 V Ta = -10 to +70 °C	-500	_0_	+500	ppm	25°C reference

Unless otherwise specified Ta = +25 °C, Vcc = 5.0 V

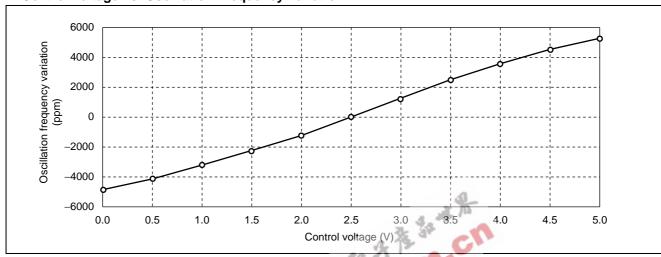
## **■ MEASURMENT CIRCUIT**



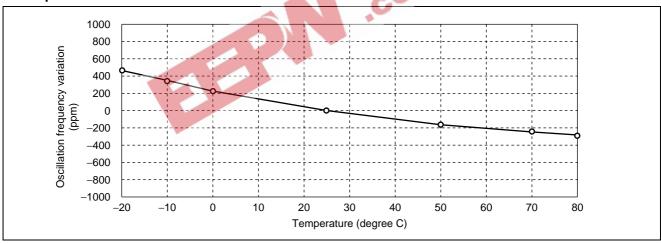
#### **■ TYPICAL CHARACTERISTICS**

Part number: FAR-M2CC-16M934-F150

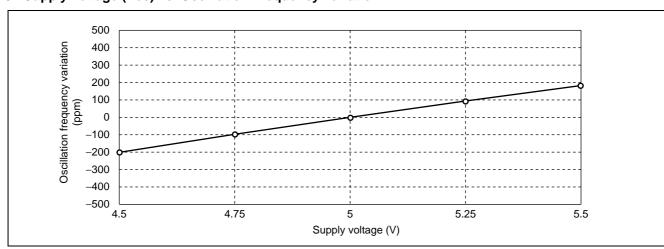
#### 1. Control Voltage vs. Oscillation Frequency Variation



#### 2. Temperature Characteristics



#### 3. Supply Voltage (Vcc) vs. Oscillation Frequency Variation



#### **■ PART NUMBER DESIGNATION**

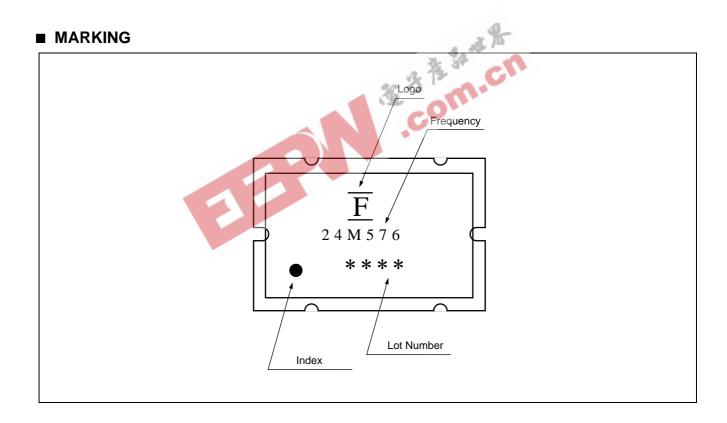
[Designation example]

(1): Frequency: This specifies the nominal frequency using six alphanumeric characters.

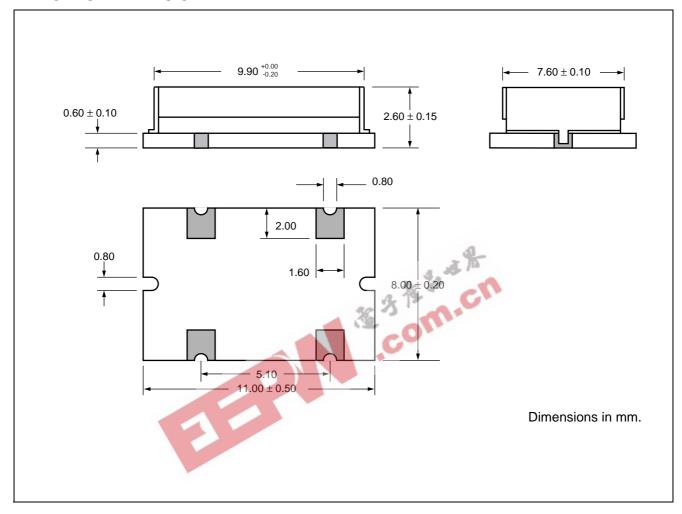
M indicates the decimal point.

[Example] 24.576 MHz  $\rightarrow$  24M576

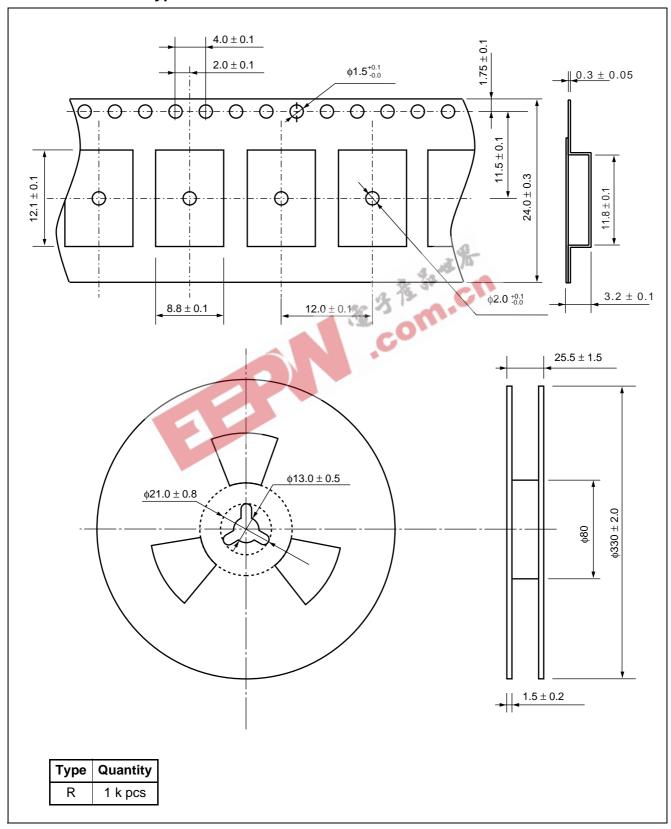
(2): Taping : "-R" means 1000 pcs/reel



## **■ PACKAGE DIMENSION**



## **■ PACKAGE:** Reel type



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